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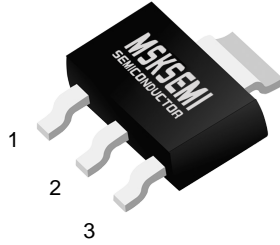


PLED

Product data sheet

SOT-223

1. BASE
2. COLLECTOR
3. EMITTER


BCP51-MS,52-MS,53-MS TRANSISTOR (PNP)
FEATURES

- For AF driver and output stages
- High collector current
- Low collector-emitter saturation voltage
- Complementary types: BCP54...BCP56 (NPN)

MAXIMUM RATINGS (T_a=25°C unless otherwise noted)

Symbol	Parameter	BCP51-MS	BCP52-MS	BCP53-MS	Unit
V _{CB0}	Collector-Base Voltage	-45	-60	-100	V
V _{CEO}	Collector-Emitter Voltage	-45	-60	-80	V
V _{EBO}	Emitter-Base Voltage	-5			V
I _C	Collector Current -Continuous	-1			A
P _C	Collector Power Dissipation	1.5			W
R _{θJA}	Thermal Resistance Junction to Ambient	94			°C/W
T _{stg}	Storage Temperature Range	-65~+150			°C

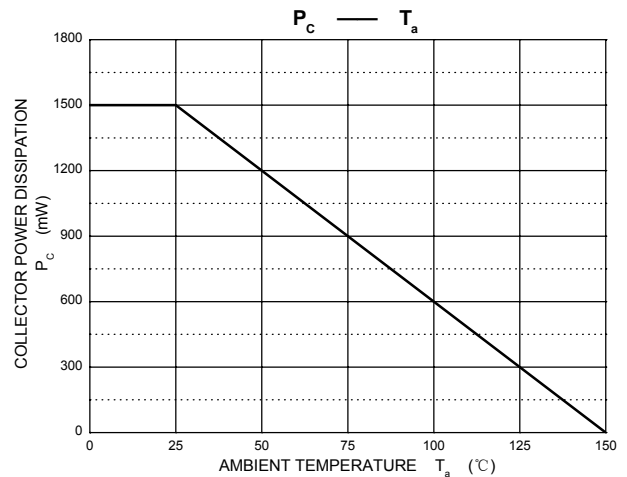
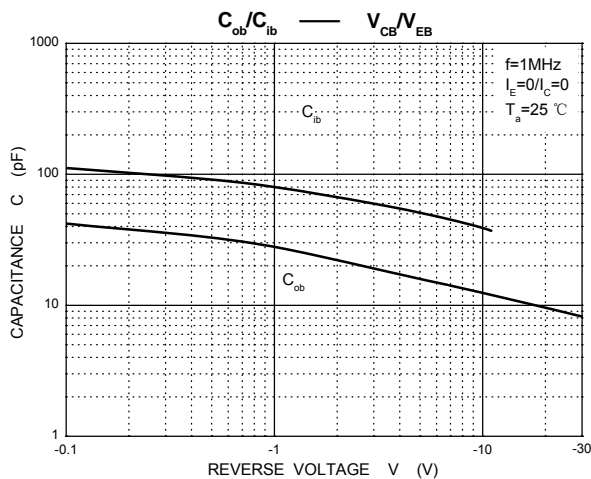
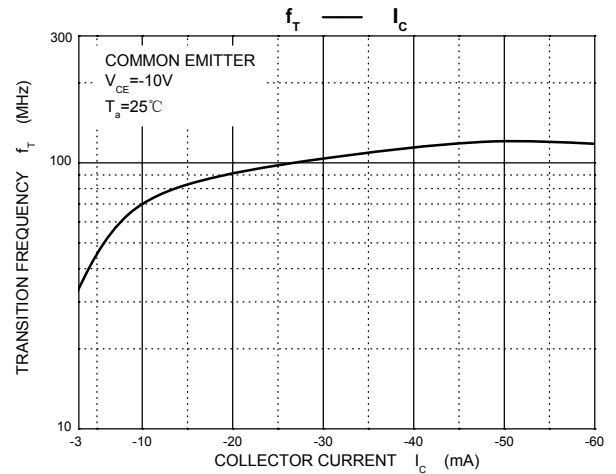
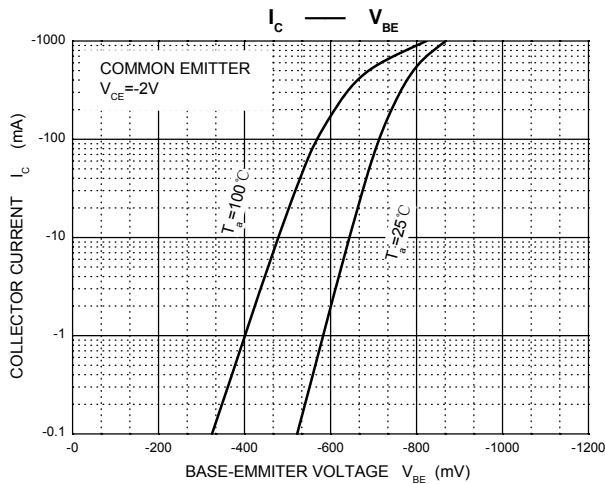
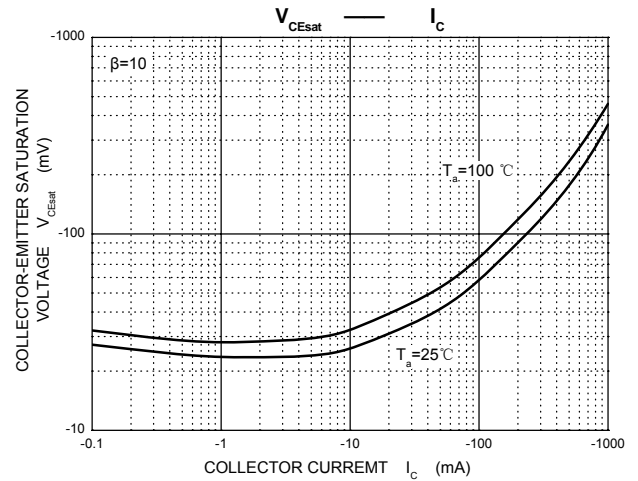
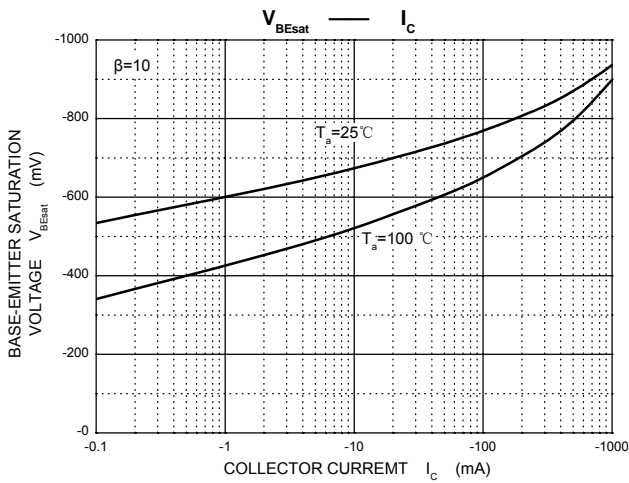
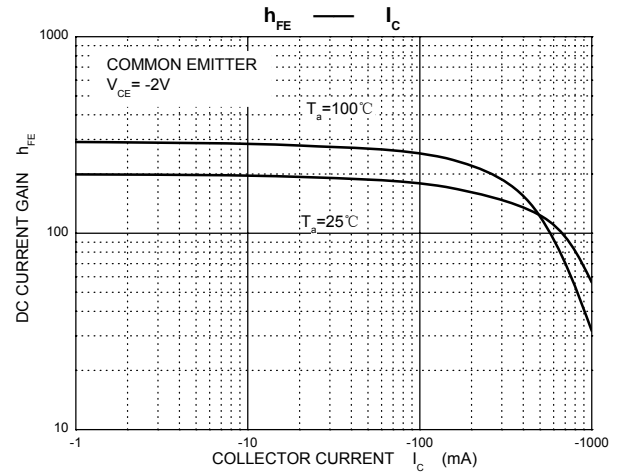
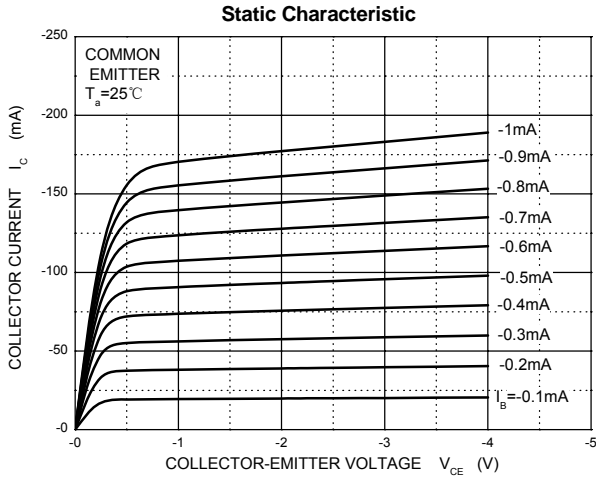
ELECTRICAL CHARACTERISTICS (T_a=25°C unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Max	Unit
Collector-base breakdown voltage	BCP51	I _C = -0.1mA, I _E =0	-45		V
	BCP52		-60		
	BCP53		-100		
Collector-emitter breakdown voltage	BCP51	I _C = -10mA, I _B =0	-45		V
	BCP52		-60		
	BCP53		-80		
Base-emitter breakdown voltage	V _{(BR)EBO}	I _E = -10μA, I _C =0	-5		V
Collector cut-off current	I _{CB0}	V _{CB} = -30 V, I _E =0		-100	nA
DC current gain	h _{FE(1)}	V _{CE} = -2V, I _C = -5mA	25		
	h _{FE(2)}	V _{CE} = -2V, I _C = -150m A	63	250	
	h _{FE(3)}	V _{CE} = -2V, I _C = -500m A	25		
Collector-emitter saturation voltage	V _{CE(sat)}	I _C = -500mA, I _B = -50mA		-0.5	V
Base-emitter voltage	V _{BE}	V _{CE} = -2V, I _C = -500m A		-1	V
Transition frequency	f _T	V _{CE} = -10V, I _C = -50mA, f=100MHz	100		MHz

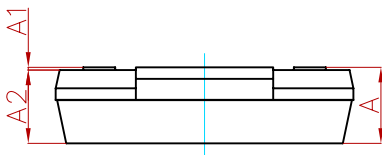
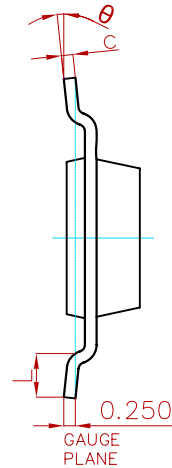
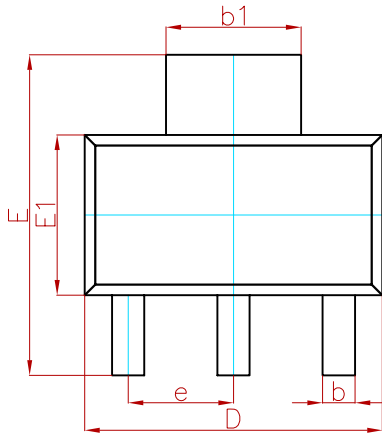
CLASSIFICATION OF h_{FE(2)}

TypE	BCP51-10,BCP52-10,BCP53-10	BCP51-16,BCP52-16,BCP53-16
Range	63-160	100-250

Typical Characteristics

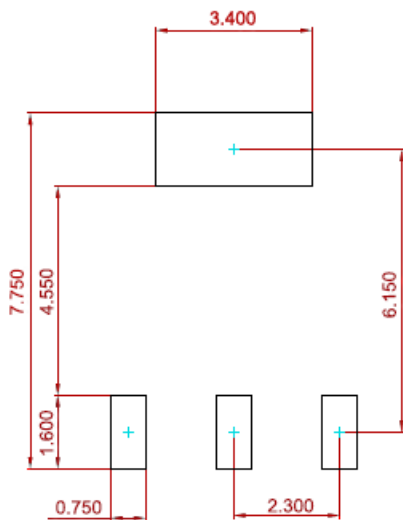


PACKAGE MECHANICAL DATA



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	—	1.800	—	0.071
A1	0.020	0.100	0.001	0.004
A2	1.500	1.700	0.059	0.067
b	0.660	0.840	0.026	0.033
b1	2.900	3.100	0.114	0.122
c	0.230	0.350	0.009	0.014
D	6.300	6.700	0.248	0.264
E	6.700	7.300	0.264	0.287
E1	3.300	3.700	0.130	0.146
e	2.300(BSC)		0.091(BSC)	
L	0.750	—	0.030	—
θ	0°	10°	0°	10°

Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: ±0.050mm.
3. The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
BCP51-MS BCP52-MS BCP53-MS	SOT-223	1000

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